Milli-Grid™ BMI (Blind Mate Interface) Connectors

Dual-row, Fully Shrouded, Through-hole, Panel-to-Board Solution

Fully shrouded 2.00mm pitch header offers the smallest blind-mating interface available for wire-to-board and panel-to-board applications across a variety of industries

Features and Benefits

Fully shrouded housing	Protects mating contact from accidental bending and damage
Wide lead-in bevel design	Self-aligns connectors without the need for direct line-of-sight or wrenching tools
Floating x- and y-axes	Helps position connectors to achieve fully mated condition
High-temperature LCP housing	Meets lead-free processing requirements
Choice of 6 PC tail lengths (2.10, 2.60, 3.00, 3.50, 4.00, 4.50mm)	Suits a variety of PCB thicknesses for greater design flexibility
Locating peg	Ensures correct connector orientation on PCB

molex





Fully Shrouded, 8-circuit, Vertical Through-hole Milli-Grid™ BMI Header with Panel-Mount Receptacle Assembly

(Remark: Wires in the photo are for illustration purposes only)

Applications

Data/Communications

High-end Computing (Servers)

Personal Computers

Hard/Optical Disk Drives

Telecommunications/Networking

Infrastructure

Consumer/Home Entertainment

Game Centers

Gaming Consoles



Personal computers and gaming consoles



Servers



Gaming centers

Panel

Floating Y-axis

Product Features

Wide bevel to align mating receptacle



Illustration showing a dual-row, 8-circuit, vertical Milli-Grid™ BMI header (Series: 151013)

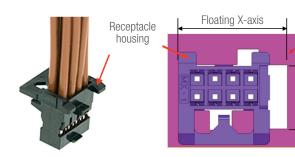


Illustration showing a dual-row, 8-circui⊤ Milli-Grid™ Panel-Mount
Receptacle with panel
(Series: 151014)

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Specifications

Reference Information

Packaging: Tube (Header)/Bulk (Receptacle)

UL File No.: E29179

CSA File No.: 1585720 (LR19980)

Mates With:

151013 with 151014 housing 151013 with 51110 housing

Use With:

51110 housing with 50394 terminals 151014 housing and 50394 terminals

Terminal Used: Phosphor Bronze

Designed In: Millimeters

RoHS: Yes Halogen Free: Yes Glow Wire Compliant: No

Electrical

Voltage (max.): 125V Current (max.): 2.0A

Contact Resistance: 40 milliohms

Dielectric Withstanding Voltage: 1000V AC (1 minute)

Insulation Resistance: 1000 megohms

Mechanical

Contact Retention to Housing (Header):

8.5N min per pin

Contact Retention to Housing (Receptacle):

9.8N min per pin

Mating Force: 1.9N max per pin Unmating Force: 0.35N min per pin Durability (min.): 25 cycles

Physical

Housing (Header): LCP, glass-filled, UL 94V-0, Black Housing (Receptacle): PBT, UL 94V-0, Black Contact: Phosphor Bronze, 0.50mm square

Plating:

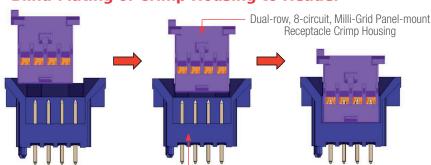
Contact Area — Refer to table below Solder Tail Area — 1.27µm Matte Tin (Sn) Underplating — 1.27µm Nickel (Ni) Operating Temperature: 0 to +75°C

Ordering Information

Series No.	Component	Orientation	Plating Option	Tail Length Option	Circuit Sizes
<u>151013</u> PCB Header					04
					06
	Peg	151013-X X X X 2-0.76µm Gold (Au) 3-0.38µm Gold (Au) 4-0.05µm Gold (Au)	151013-XXXX 0-2.60mm 1-4.00mm 2-3.00mm 3-3.50mm 4-4.50mm 5-2.10mm	08	
				10	
				12	
				14	
				16	
				18	
				20	
<u>151014</u>	Crimp Receptacle Housing	N.A.	N.A.	N.A.	8*
<u>50394</u>	Crimp Receptacle Terminal N	N.A.	50394–805 X 1–0.38µm Gold (Au) 2–0.76µm Gold (Au) 4–0.05µm Gold (Au)	N.A.	N.A.

Contact sales for 6, 10, 12 and 14 circuit version enquiries

Blind-Mating of Crimp Housing to Header



Dual-row, 8-circuit, Vertical, Milli-Grid™ Fully Shrouded BMI Header (Series 151013)

Cross-section illustration showing mating sequence of Dual-row, 8-circuit, Milli-Grid[™] Panel-mount Receptacle Crimp Housing (Series 151014, top) with Vertical Milli-Grid[™] BMI Header (Series 151013, bottom)

www.molex.com/product/milligrid.html